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April 1st, 2010 Renesas Electronics Corporation

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MOS FIELD EFFECT TRANSISTOR $\mu PA2454$

N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

The μ PA2454 is a switching device which can be driven directly by a 2.5 V power source.

This μ PA2454 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- 2.5 V drive available
- · Low on-state resistance

 $R_{DS(on)1} = 10.0 \text{ m}\Omega \text{ TYP.}$ (Vgs = 4.5 V, ID = 4.0 A)

 $R_{DS(on)2} = 10.5 \text{ m}\Omega \text{ TYP.}$ (Vgs = 4.0 V, ID = 4.0 A)

 $R_{DS(on)3} = 13.0 \text{ m}\Omega \text{ TYP.} \text{ (Vgs} = 3.1 \text{ V, I}_D = 4.0 \text{ A)}$

 $R_{DS(on)4} = 15.5 \text{ m}\Omega \text{ TYP.}$ (Vgs = 2.5 V, ID = 4.0 A)

· Built-in G-S protection diode against ESD

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

| Drain to Source Voltage (VGS = 0 V) | VDSS | 24.0 | V |
|---|-----------------------|-------------|----|
| Gate to Source Voltage (Vps = 0 V) | Vgss | ±12.0 | V |
| Drain Current (DC) Note1 | ID(DC) | ±15.0 | Α |
| Drain Current (pulse) Note2 | I _{D(pulse)} | ±100 | Α |
| Total Power Dissipation (2 units) Note1 | P _{T1} | 2.5 | W |
| Total Power Dissipation (2 units) Note3 | P _{T2} | 0.7 | W |
| Channel Temperature | T_ch | 150 | °C |
| Storage Temperature | T_{stg} | -55 to +150 | °C |
| | | | |

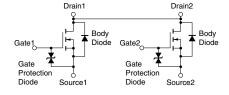
- Notes 1. Mounted on ceramic substrate of 50 cm² x 1.1 mm
 - **2.** PW \leq 10 μ s, Duty Cycle \leq 1%
 - 3. Mounted on FR-4 board of 50 cm² x 1.6 mm

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

4.4±0.1 5.0±0.1 (0.9) (0.9) (0.9) (0.50) Each lead has same dimensions 1,2: Source 1 3,6: Source 2 3: Gale 1 4: Gale 2

PACKAGE DRAWING (Unit: mm)

EQUIVALENT CIRCUIT



ORDERING INFORMATION

| PART NUMBER | LEAD PLATING | PACKING | PACKAGE |
|--------------------------------|--------------|-------------|----------------------|
| μPA2454TL-E1-A ^{Note} | 0 5 | Reel | 0PIN IIMOON (4504) |
| μPA2454TL-E2-A ^{Note} | Sn-Bi | 3000 p/reel | 6PIN HWSON (4521) |

Note Pb-free (This product does not contain Pb in the external electrode and other parts.)

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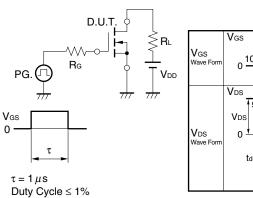


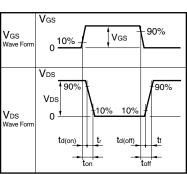
ELECTRICAL CHARACTERISTICS (TA = 25°C)

| | • | • | | | | |
|--|----------------------|---|------|------|-------|------|
| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = 24.0 V, V _{GS} = 0 V | | | 1.0 | μΑ |
| Gate Leakage Current | Igss | V _{GS} = ±12.0 V, V _{DS} = 0 V | | | ±10.0 | μΑ |
| Gate Cut-off Voltage | V _{GS(off)} | V _{DS} = 10.0 V, I _D = 1.0 mA | 0.5 | 1.0 | 1.5 | ٧ |
| Forward Transfer Admittance Note | yfs | V _{DS} = 10.0 V, I _D = 4.0 A | 5.0 | | | S |
| Drain to Source On-state Resistance Note | RDS(on)1 | V _{GS} = 4.5 V, I _D = 4.0 A | 6.0 | 8.0 | 10.0 | mΩ |
| | RDS(on)2 | V _{GS} = 4.0 V, I _D = 4.0 A | 6.3 | 8.3 | 10.5 | mΩ |
| | RDS(on)3 | V _{GS} = 3.1 V, I _D = 4.0 A | 7.0 | 9.5 | 13.0 | mΩ |
| | RDS(on)4 | V _{GS} = 2.5 V, I _D = 4.0 A | 8.0 | 11.5 | 15.5 | mΩ |
| Input Capacitance | Ciss | V _{DS} = 10.0 V | | 1000 | | pF |
| Output Capacitance | Coss | V _{GS} = 0 V | | 200 | | pF |
| Reverse Transfer Capacitance | Crss | f = 1.0 MHz | | 110 | | pF |
| Turn-on Delay Time | t _{d(on)} | V _{DD} = 20.0 V | | 4.6 | | μs |
| Rise Time | tr | I _D = 4.0 A | | 11.6 | | μs |
| Turn-off Delay Time | t _{d(off)} | V _{GS} = 4.0 V | | 14.5 | | μs |
| Fall Time | t f | R _G = 6.0 Ω | | 18.5 | | μs |
| Total Gate Charge | QG | V _{DD} = 20.0 V | | 11.5 | | nC |
| Gate to Source Charge | QGS | V _{GS} = 4.0 V | | 2.5 | | nC |
| Gate to Drain Charge | Q _{GD} | I _D = 8.0 A | | 4.5 | | nC |
| Body Diode Forward Voltage Note | V _{F(S-D)} | I _F = 8.0 A, V _{GS} = 0 V | | 0.81 | | V |

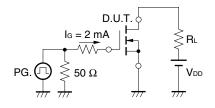
Note Pulsed: PW \leq 350 μ s, Duty Cycle \leq 2%

TEST CIRCUIT 1 SWITCHING TIME



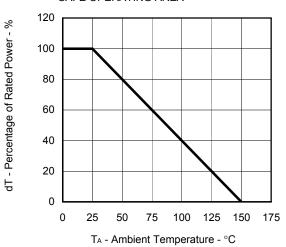


TEST CIRCUIT 2 GATE CHARGE

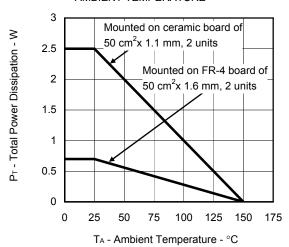




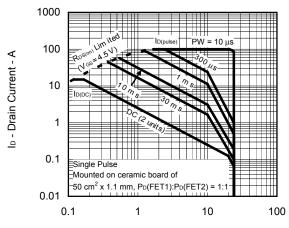
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE

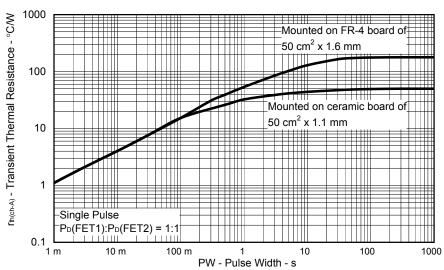


FORWARD BIAS SAFE OPERATING AREA



VDS - Drain to Source Voltage - V

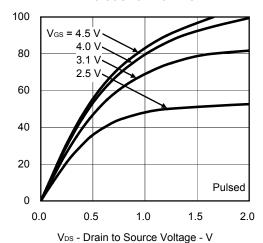
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



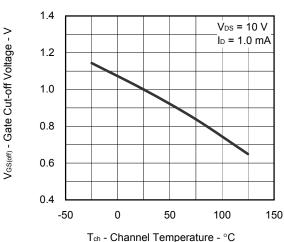


lo - Drain Current - A

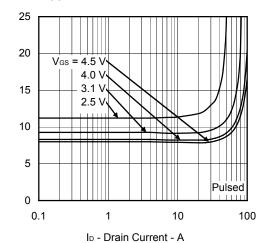
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



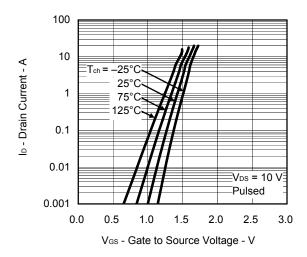
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



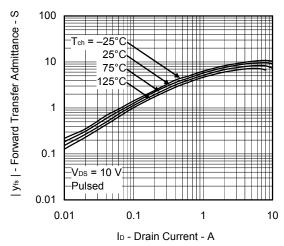
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



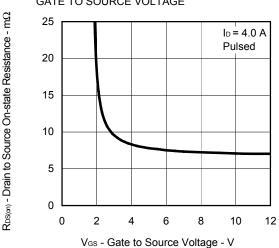
FORWARD TRANSFER CHARACTERISTICS



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

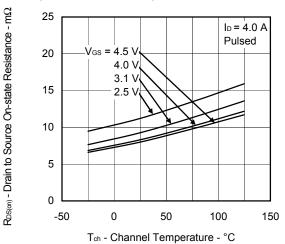


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

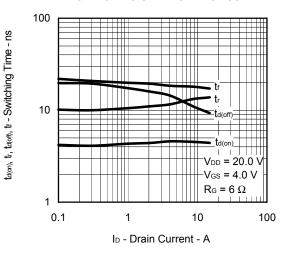


R_{DS(m)} - Drain to Source On-state Resistance - mΩ

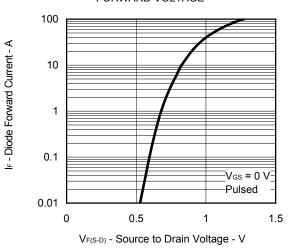
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



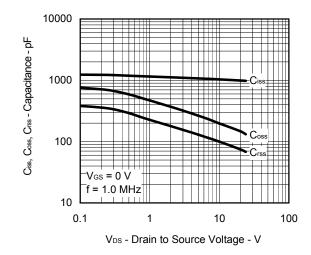
SWITCHING CHARACTERISTICS



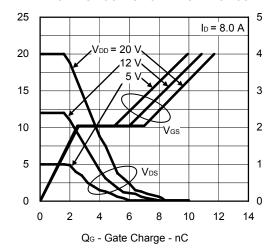
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



DYNAMIC INPUT/OUTPUT CHARACTERISTICS



Ves - Gate to Source Voltage - V

Vps - Drain to Source Voltage - V



<Notes for using this device safely>

When you use this device, in order to prevent a customer's hazard and damage, use it with understanding the following contents. If used exceeding recommended conditions, there is a possibility of causing failure of the device and characteristic degradation.

- 1. When you mount the device on a substrate, carry out within our recommended soldering conditions of infrared reflow. If mounted exceeding the conditions, the characteristic of a device may be degraded and it may result failure.
- 2. When you wash the device mounted the substrate, carry out within our recommended conditions. If washed exceeding the conditions, the characteristic of a device may be degraded and it may result in failure.
- 3. When you use ultrasonic wave to substrate after the device mounting, prevent from touching a resonance generator directly. If it touches, the characteristic of a device may be degraded and it may result in failure.
- 4. Please refer to **Figure 1** as an example of the land pattern. Optimize the land pattern in consideration of density, appearance of solder fillets, common difference, etc in an actual design.

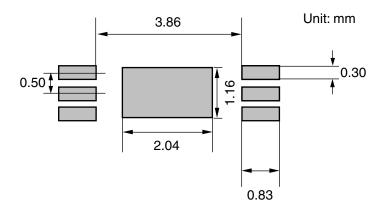


Figure 1. Example of the land pattern



5. This device is very thin device and should be handled with caution for mechanical stress. The rate of distortion applied to the device should become below 2000 $\mu\epsilon$. Note1 If the rate of distortion exceeds 2000 $\mu\epsilon$, the characteristic of a device may be degraded and it may result in failure.

Figure 2. Direction of substrate and stress

The substrate that mounted the device is on a stand with a support width of 24 mm.

The device is turned downward. The stress is applied from a top.

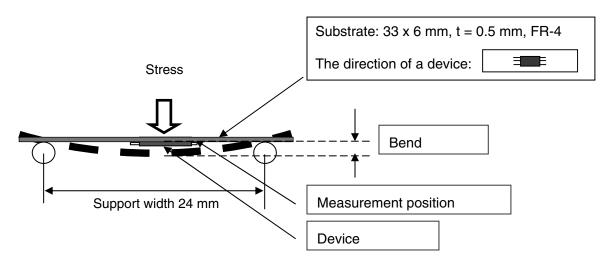
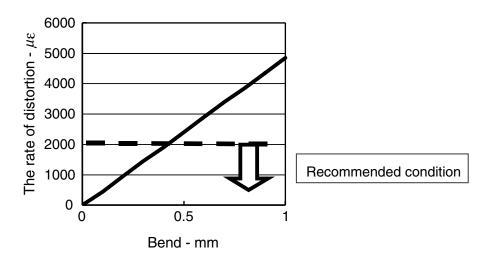


Figure 3. Example of the bend and the rate of distortion Note2



Note 1. Definition (written as ε in this document)

- $\varepsilon = (I I_0)/I_0$
- lo: Distance for two arbitrary points before receiving stress.
- I: Distance above-mentioned when receiving stress.
- **2.** The relation of the distortion and the bend changes with several conditions, such as a size of substrate and so on.

Data Sheet G20063EJ1V1DS 7



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